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Datasheet of CD4086BE - IC 2-IN AND-OR-INV GATE 14-DIP

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Data sheet acquired from Harris Semiconductor SCHS061C – Revised September 2003

## CD4086B Types

# CMOS Expandable 4-Wide 2-Input AND-OR-INVERT Gate

High-Voltage Types (20-Volt Rating)

CD4086B contains one 4-wide 2-input AND-OR-INVERT gate with an INHIBIT/EXP input and an ENABLE/EXP input. For a 4-wide A-O-I function INHIBIT/EXP is tied to V<sub>SS</sub> and ENABLE/EXP to V<sub>DD</sub>. See Fig.10 and its associated explanation for applications where a capability greater than 4-wide is required.

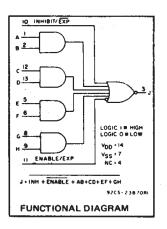
The CD4086B types are supplied in 14-lead hermetic dual-in-line ceramic packages (F3A suffix), 14-lead dual-in-line plastic packages (E suffix), 14-lead small-outline packages (M, MT, M96, and NSR suffixes), and 14-lead thin shrink small-outline packages (PW and PWR suffixes).

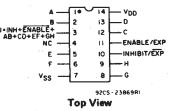
#### Features:

- Medium-speed operation tpHL = 90 ns; tpLH = 140 ns (typ.) at 10 V
- INHIBIT and ENABLE inputs
- Buffered outputs
- 100% tested for quiescent current at 20 V
- Maximum input leakage current of 18 V over full package-temperature range; 100 nA at 18 V and 25°C
- Noise margin (over full package termperature range):

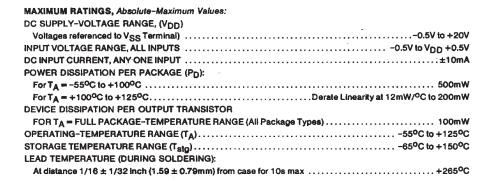
1 V at V<sub>DD</sub> = 5 V 2 V at V<sub>DD</sub> = 10 V 2.5 V at V<sub>DD</sub> = 15 V

- Standardized, symmetrical output characteristics
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"





TERMINAL ASSIGNMENT



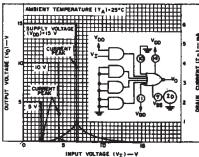


Fig. 1 — Typical voltage and current transfer characteristics.

#### RECOMMENDED OPERATING CONDITIONS

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

	LIM			
CHARACTERISTIC	MIN.	MAX.	UNITS	
Supply-Voltage Range (For T <sub>A</sub> = Full Package- Temperature Range)	3	18	٧	

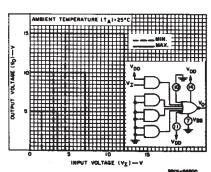


Fig. 2 — Minimum and maximum voltage transfer characteristics.



### CD4086B Types

#### STATIC ELECTRICAL CHARACTERISTICS

CHARAC- TERISTIC		DITIO	VS.	LIMI	TS AT I	NDICAT	ED TE	//PERAT	rures (°	PC)	UNITS
LEMISTIC	· Vo	VIN	VDD						+25		
	(V).	(V)	(V)	55	<b>-40</b>	+85	+125	Min.	Тур.	Max.	
Quiescent	_	0,5	5	1	1	30	30	72	0.02	1	
Device		0,10	10	2	2	60	60		0.02	2	
Current	_	0,15	15	4	4	120	120		0.02	4	μΑ
IDD Max.	_	0,20	20	20	20	600	600	-	0.04	20	
Output Low								. ,			
(Sink)	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	35.54	54	
Current,	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6		
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	_	
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51,	-1	_	mA
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1,15	-1.6	-3.2		
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	_	
IOH Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-	
Output Volt-											
age:	_	0,5	5		0.0	)5		_	0	0.05	
Low-Level,		0,10	10		0.0	)5		_	0	0.05	
VOL Max.	a 7 a	0,15	15	0.05				-	0	0.05	v
Output Volt-		F. 41									•
age:		0,5	5		4.9	95		4.95	5	_	
High-Level,	_	0,10	10		9.9	95		9.95	10		
V <sub>OH</sub> Min.		0,15	15		14.	95		14.95	15	-	
Input Low	0.5,4.5		5		1.	5			_	1.5	
Voltage,	1,9	-	10		3			_	. –	3	
V <sub>IL</sub> Max.	1.5,13.5	_	15		4				_	4	.,
Input High	0.5,4.5	_	5		3.5		3.5	_		٧	
Voltage,	1,9	主力	10	7		7	_	_			
V <sub>IH</sub> Min.	1.5,13.5	+	15		1	1		11	-		
Input Current, I <sub>IN</sub> Max.		0,18	18	±0.1	±0.1	±1	±1	_	±10-5	±0.1	μΑ

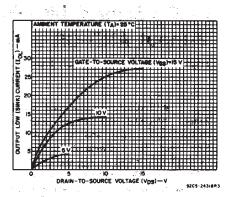


Fig. 3 — Typical output low (sink) current characteristics.

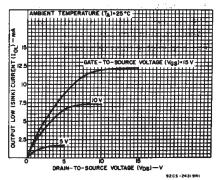


Fig. 4 — Minimum output low (sink) current characteristics.

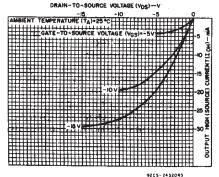


Fig.5 - Typical output high (source) current characteristics.

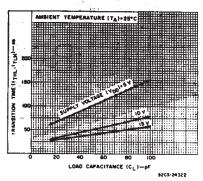


Fig.6 - Typical transition time vs. load capacitance.

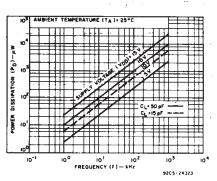


Fig.7 - Typical power dissipation vs. frequency.

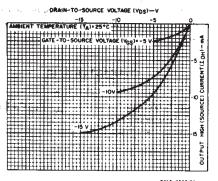


Fig.8 — Minimum output high (source)
current characteristics.



#### CD4086B Types

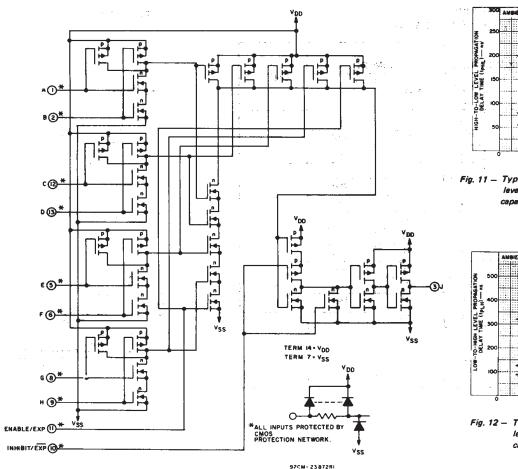


Fig. 11 - Typical DATA or ENABLE high-to-low level propagation delay time vs. load capacitance.

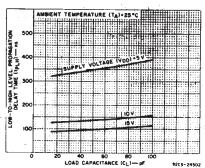


Fig. 12 - Typical DATA or ENABLE low-to-high level propagation delay time vs. load capacitance.

Fig. 9 - CD4086B schematic diagram.

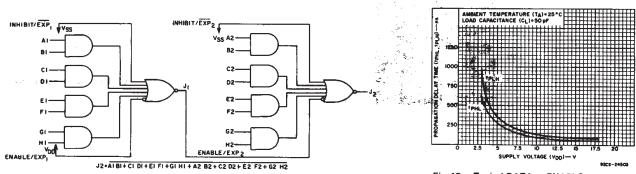


Fig. 10 - Two CD40868's connected as an 8-wide 2-input A-O-I gate.

Fig. 10 above shows two CD4086's utilized to obtain an 8-wide 2-input A-O-I function. The output (J1) of one CD4086 is fed directly to the ENABLE/EXP2 line of the second CD4086. In a similar fashion, any

NAND gate output can be fed directly into the ENABLE/EXP input to obtain a 5-wide A-O-I function. In addition, any AND gate output can be fed directly into the IN-HIBIT/EXP input with the same result.

Fig. 13 - Typical DATA or ENABLE propagation delay time vs. supply voltage.



## CD4086B Types

#### **DYNAMIC ELECTRICAL CHARACTERISTICS**

At  $T_A = 25^{\circ}C$ ; Input  $t_r$ ,  $t_f = 20$  ns,  $C_L = 50$  pF,  $R_L = 200$  k $\Omega$ 

	CONDI	TIONS	LII		
CHARACTERISTIC		V <sub>DD</sub> (V)	TYP.	MAX.	UNITS
Propagation Delay Time		5	225	450	
(Data):		10	90	180	ns
High-to-Low Level, tpHL		15	60	120	1
		5	310	620	
Low-to-High Level, tpLH		10	125	250	ns
		15	90	180	]
Propagation Delay Time		5	150	300	
(Inhibit): High-to-Low		10	60	120	ns
Level, tPHL(INH)		15	40	80	1
Laure III-laure		5	250	500	
Low-to-High Level,		10	100	200	ns
<sup>t</sup> PLH(INH)		15	70	140	1
Tuesdales Ties		5	100	200	
Transition Time,		10	50	100	ns
tTHL <sup>, t</sup> TLH		15	40	80	]
Input Capacitance CIN	Any	nout	5	7.5	ρF

#### **TEST CIRCUITS**

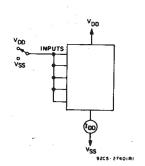


Fig. 14 - Quiescent device current,

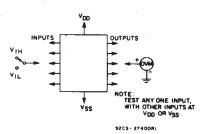
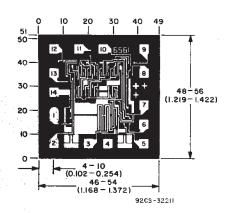


Fig. 15 - Input voltage.



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3})$  inch).

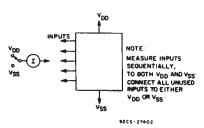


Fig. 16 - Input leakage current.

Dimensions and Pad Layout for the CD4086BH

1,757



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PACKAGE OPTION ADDENDUM

10-Jun-2014

#### **PACKAGING INFORMATION**

Orderable Device Package Type Package Pins Package Lead/Ball Finish Device Marking Status Eco Plan MSL Peak Temp Op Temp (°C) Samples Qty Drawing (1) (2) (6) (3) ACTIVE PDIP CU NIPDAU CD4086BE CD4086BE 14 Pb-Free N / A for Pkg Type -55 to 125 Ν 25 Samples (RoHS) CD4086BF3A CD4086BF3A **ACTIVE** CDIF J 14 1 TBD A42 N / A for Pkg Type -55 to 125 CD4086BM ACTIVE SOIC D 14 50 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -55 to 125 CD4086BM & no Sb/Br) CD4086BME4 ACTIVE SOIC CU NIPDAU CD4086BM D 14 50 Green (RoHS Level-1-260C-UNLIM -55 to 125 & no Sb/Br) CD4086BMT ACTIVE SOIC D 14 250 Green (RoHS CU NIPDAU Level-1-260C-UNLIM -55 to 125 CD4086BM & no Sb/Br)

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): Tl's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

Addendum-Page 1



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PACKAGE OPTION ADDENDUM

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(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD4086B. CD4086B-MIL:

- Catalog: CD4086B
- Military: CD4086B-MIL

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

Addendum-Page 2

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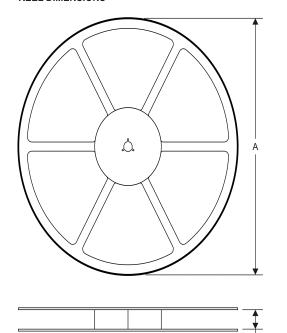


## **PACKAGE MATERIALS INFORMATION**

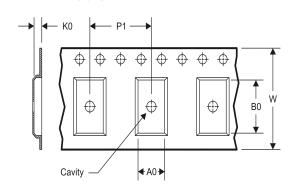
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#### **TAPE AND REEL INFORMATION**

#### **REEL DIMENSIONS**



#### **TAPE DIMENSIONS**



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### TAPE AND REEL INFORMATION

\*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD4086BMT	SOIC	D	14	250	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



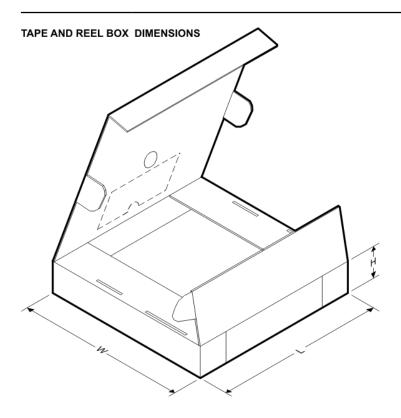
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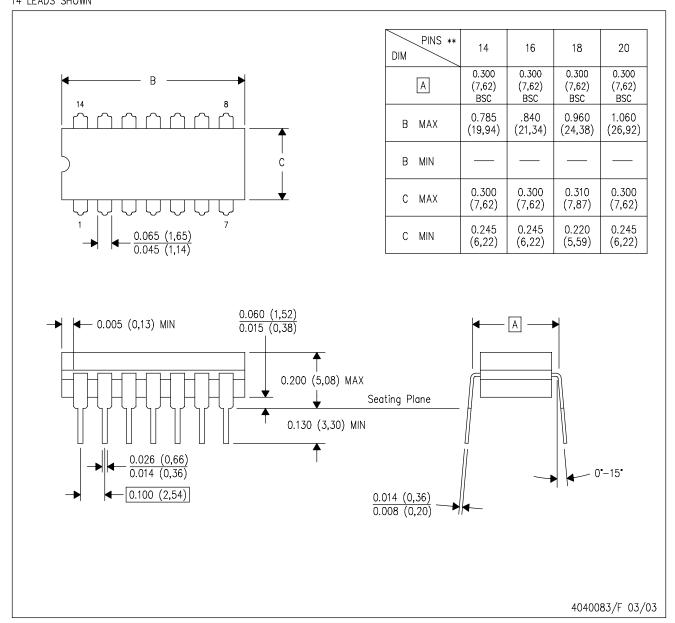
#### \*All dimensions are nominal

 iii diiiiidiidiidiid did iidiiiiiidi							
Device Package Type		Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
CD4086BMT	SOIC	D	14	250	367.0	367.0	38.0

## J (R-GDIP-T\*\*)

### CERAMIC DUAL IN-LINE PACKAGE

14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

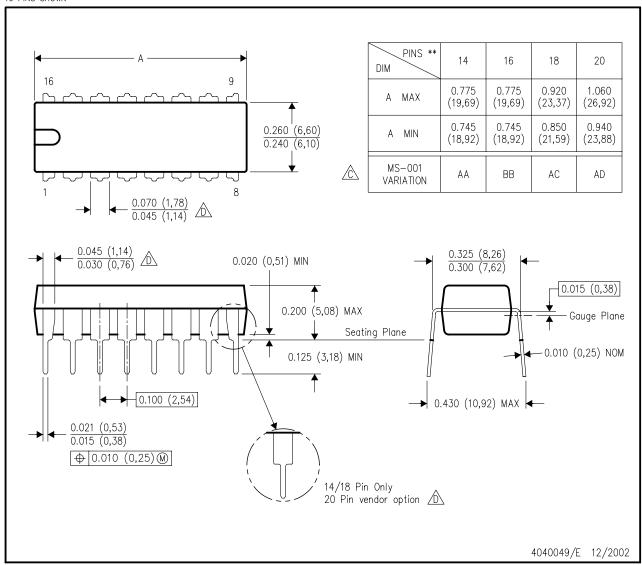


#### **MECHANICAL DATA**

## N (R-PDIP-T\*\*)

## PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- a. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.

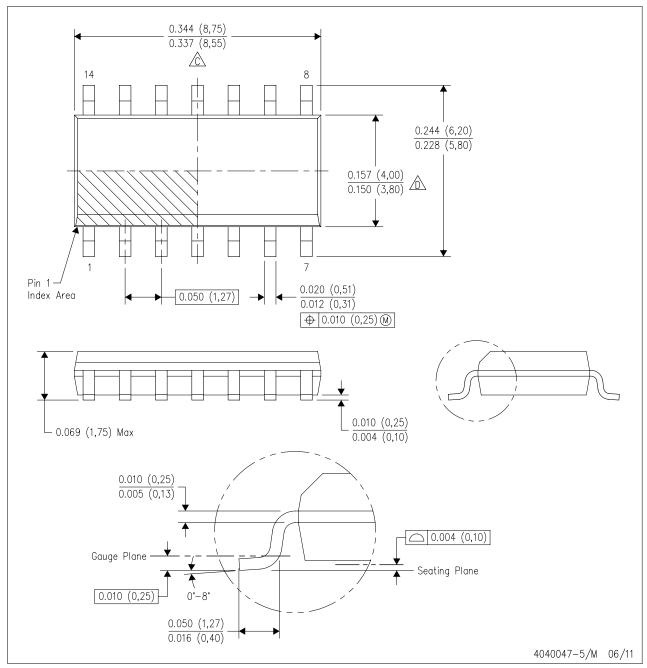




#### **MECHANICAL DATA**

## D (R-PDS0-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



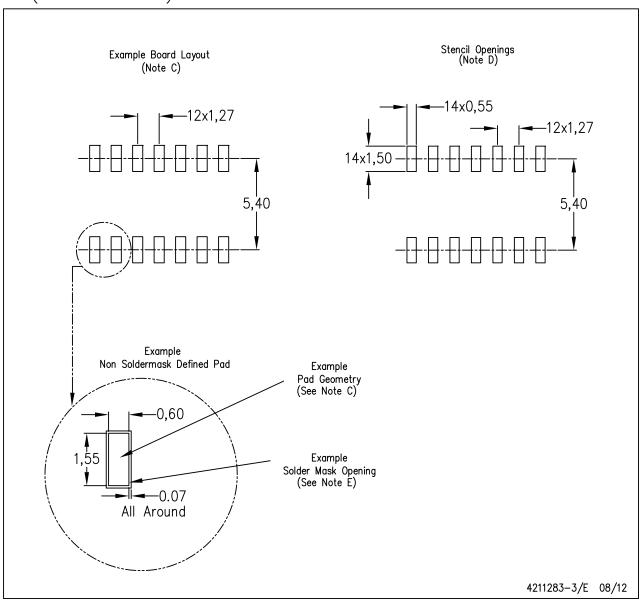




#### LAND PATTERN DATA

## D (R-PDSO-G14)

#### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





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